

REV.	DESCRIPTION	CHANGED	ECN/NO.	DATE
A0	NEW ISSUE			2012/8/17

NOTE:

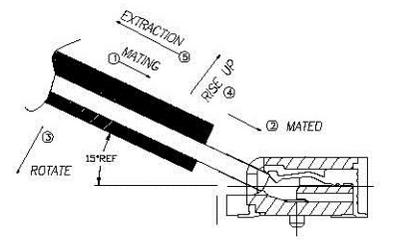
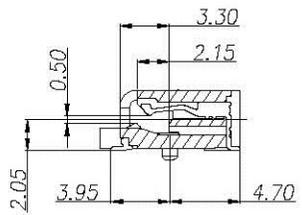
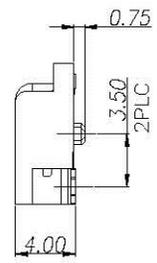
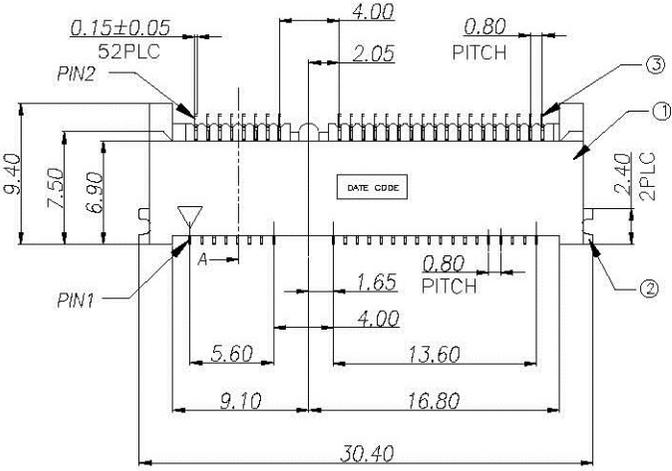
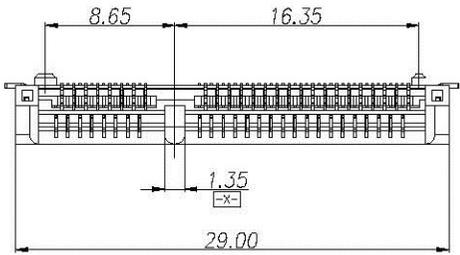
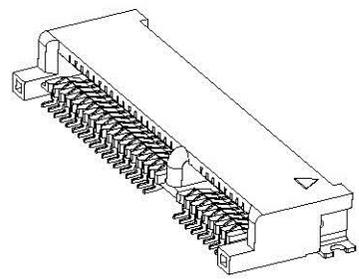
1.MATERIAL:

- 1.1.HOUSING: LCP HIGH TEMPERATURE THERMOPLASTIC,UL94V-0,COLOR:BLACK
- 1.2.CONTACTS: COPPER ALLOY;;
- 1.3.PEG: COPPER ALLOY.

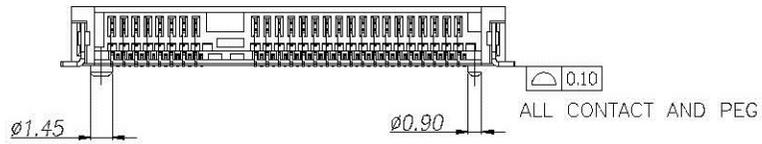
2.REFLOW SOLDER CAPABLE TO 260°C

3.FINISH:

- CONTACT: GOLD FLASH PLATE ON CONTACT AREA
- 1.27um(50u")MIN NICKEL UNDERPLATE OVERALL
- PEG: 2.54um[100u"] MIN.MATTE-TIN.
- 1.27um[50

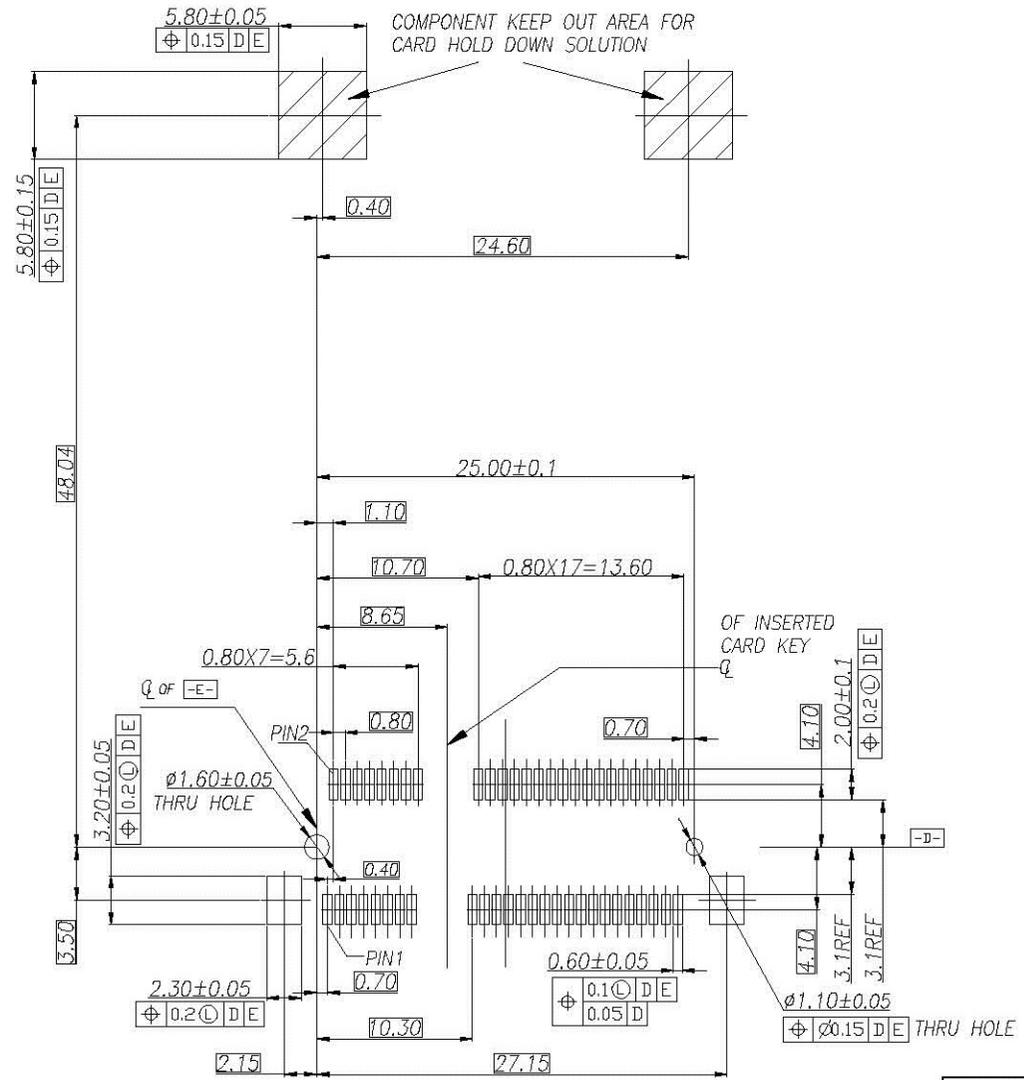


HOW TO MATE AND UNMATE
MATE ①—②
UNMATE ③—④



深圳市连欣科技有限公司									
公差参考表			产品名称		MINI PCIE 52P 0.8PH H:4.0				
X	±0.35	ANGLE		产品编号		XDMP-040-A02			
X.X	±0.25	X°	±2°	核准		版本	A0	单位	MM
X.XX	±0.15	X.X°	±1.0°	审核		单重		比例	
X.XXX	±0.050	X.XX°	±0.50°	制图		隆强	类型	页数	1/1

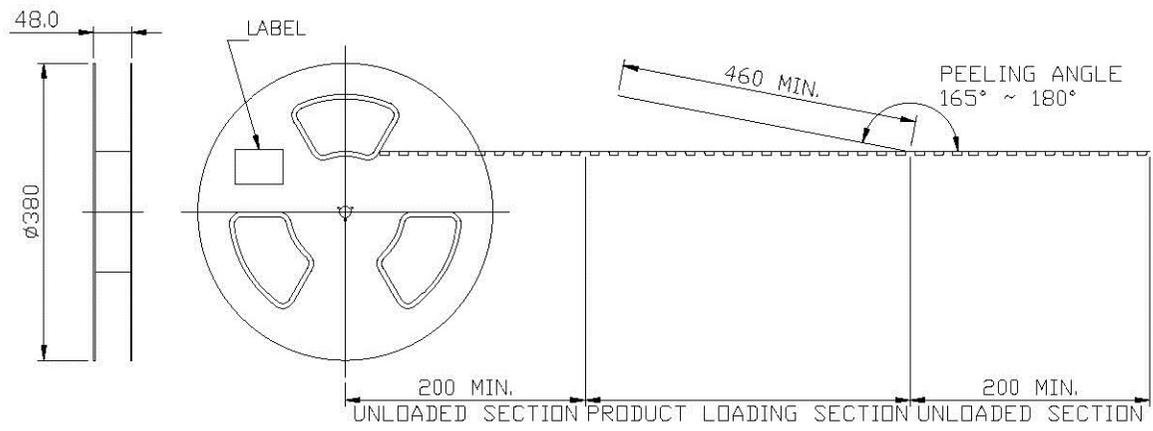
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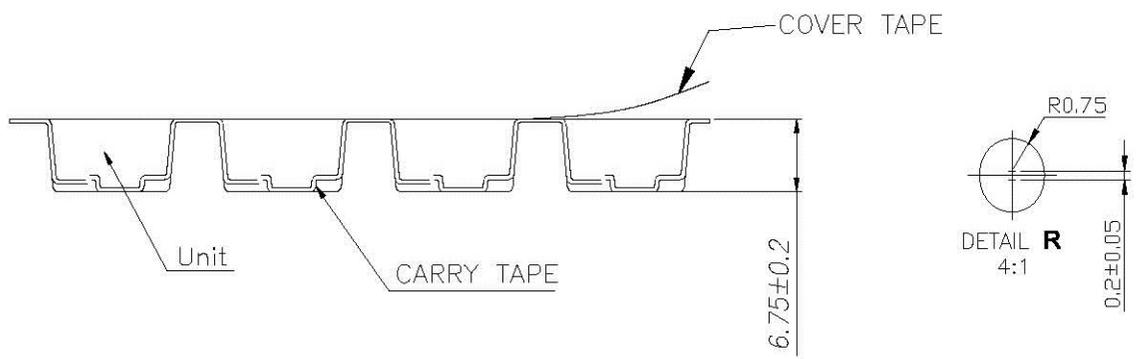
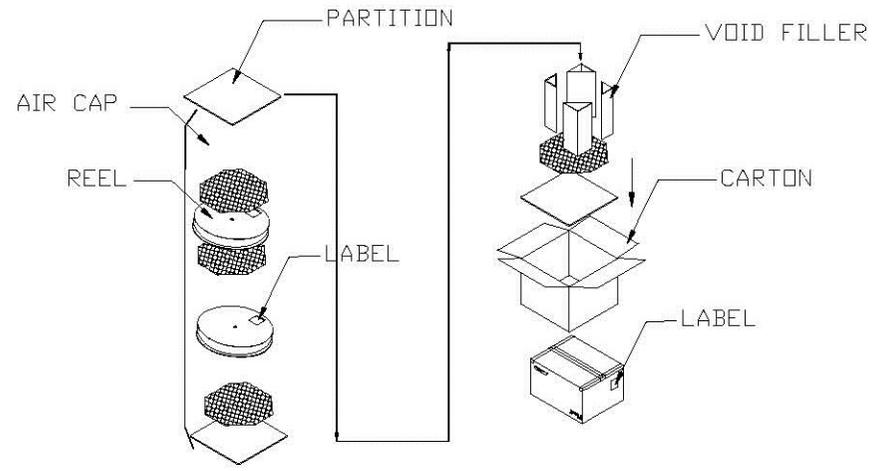
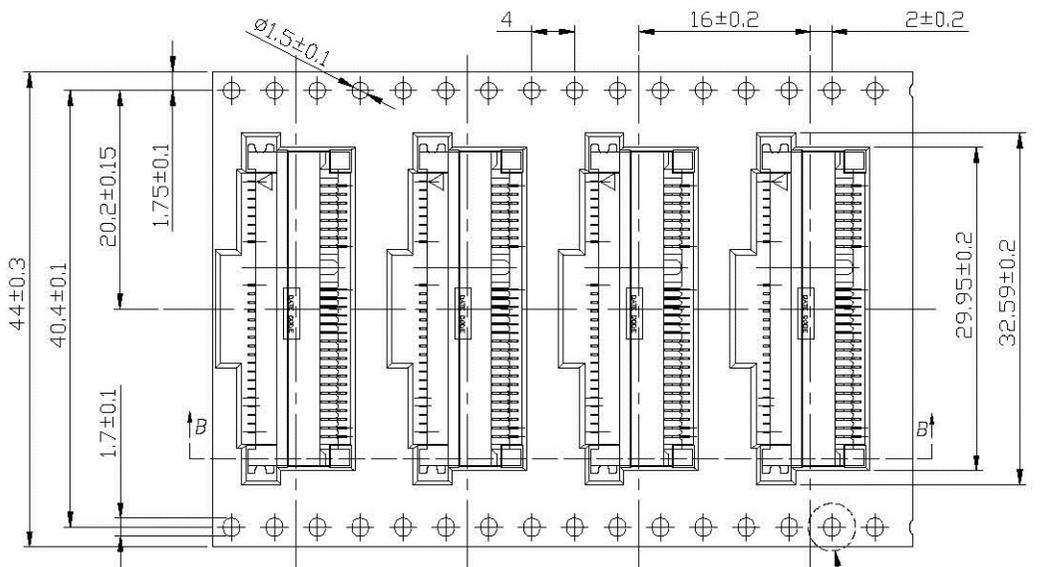
RECOMMENDED PCB LAYOUT
THICKNESS: 1.20±0.05mm

<h2 style="text-align: center;">深圳市连欣科技有限公司</h2>						
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- NOTES :
- MATERIAL :
COVER TAPE : ANTISTATIC P.S T=0.05±0.01 ,COLOR: :CLEAR
CARRIER TAPE : ANTISTATIC P.S T=0.40±0.10
REEL : PS UL94V-0
CARTON: CORRUGATED FIBER
 - DIMENSION :
REEL : SEE DRAWING
SHIPPING BOX: 385X385X248mm
 - QUANTITY : SEE TABLE
 - PEELING RESISTANCE : 10gf~130gf (for 12~56mm)
 - PEELING SPEED : 300mm/MINUTES



X.XXKG	X.XXKG	900	5	4500	PCI-52SGA0202
GROSS W/FIGHT	NET WEIGHT	PCS/ RFFL	REEL/ CARTON	PCS/ CARTON	PART NUMBER

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			单位
			比例
			页数
			1/1

核准	版本	A0	单位	MM
审核	单重		比例	
制图	类型		页数	1/1